### 3.3 V Zero Delay Clock Buffer

## NB2309A

The NB2309A is a versatile, 3.3 V zero delay buffer designed to distribute high-speed clocks. It accepts one reference input and drives out nine low-skew clocks. It is available in a 16 pin package.

The -1 H version of the NB2309A operates at up to 133 MHz , and has higher drive than the -1 devices. All parts have on-chip PLL's that lock to an input clock on the REF pin. The PLL feedback is on-chip and is obtained from the CLKOUT pad.

The NB2309A has two banks of four outputs each, which can be controlled by the Select inputs as shown in the Select Input Decoding Table. If all the output clocks are not required, Bank B can be three-stated. The select inputs also allow the input clock to be directly applied to the outputs for chip and system testing purposes.

Multiple NB2309A devices can accept the same input clock and distribute it. In this case the skew between the outputs of the two devices is guaranteed to be less than 700 ps .

All outputs have less than 200 ps of cycle-to-cycle jitter. The input and output propagation delay is guaranteed to be less than 350 ps , and the output to output skew is guaranteed to be less than 250 ps .

The NB2309A is available in two different configurations, as shown in the ordering information table. The NB2309A1 is the base part. The NB2309AI1H is the high drive version of the -1 and its rise and fall times are much faster than -1 part.

## Features

- 15 MHz to 133 MHz Operating Range, Compatible with CPU and PCI Bus Frequencies
- Zero Input - Output Propagation Delay
- Multiple Low-Skew Outputs
- Output-Output Skew Less than 250 ps
- Device-Device Skew Less than 700 ps
- One Input Drives 9 Outputs, Grouped as $4+4+1$
- Less than 200 ps Cycle-to-Cycle Jitter is Compatible with Pentium ${ }^{\circledR}$ Based Systems
- Test Mode to Bypass PLL
- Accepts Spread Spectrum Clock at the Input
- Available in 16 Pin, 150 mil SOIC and 4.4 mm TSSOP
- 3.3 V Operation, Advanced $0.35 \mu$ CMOS Technology
- Guaranteed Across Commercial and Industrial Temperature Ranges
- These Devices are $\mathrm{Pb}-$ Free, Halogen Free/BFR Free and are RoHS Compliant

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ORDERING INFORMATION
See detailed ordering, marking and shipping information in the package dimensions section on page 7 of this data sheet.

NB2309A


Figure 1. Block Diagram

Table 1. SELECT INPUT DECODING

| S2 | S1 | Clock A1-A4 | Clock B1- B4 | CLKOUT <br> (Note 1) | Output Source | PLL <br> ShutDown |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | Three-state | Three-state | Driven | PLL | N |
| 0 | 1 | Driven | Three-state | Driven | PLL | N |
| 1 | 0 | Driven | Driven | Driven | Reference | Y |
| 1 | 1 | Driven | Driven | Driven | PLL | N |

1. This output is driven and has an internal feedback for the PLL. The load on this output can be adjusted to change the skew between the reference and the output.

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Figure 2. Pin Configuration

Table 2. PIN DESCRIPTION

| Pin \# | Pin Name |  |
| :---: | :---: | :--- |
| 1 | REF (Note 2) | Input reference frequency, 5 V tolerant input. |
| 2 | CLKA1 (Note 3) | Buffered clock output, Bank A. |
| 3 | CLKA2 (Note 3) | Buffered clock output, Bank A. |
| 4 | V DD $^{\text {GND }}$ | 3.3 V supply. |
| 5 | GND | Ground. |
| 6 | CLKB1 (Note 3) | Buffered clock output, Bank B. |
| 7 | CLKB2 (Note 3) | Buffered clock output, Bank B. |
| 8 | S2 (Note 4) | Select input, bit 2. |
| 9 | S1 (Note 4) | Select input, bit 1. |
| 10 | CLKB3 (Note 3) | Buffered clock output, Bank B. |
| 12 | CLKB4 (Note 3) | Buffered clock output, Bank B. |
| 13 | GND | Ground. |
| 14 | VDD | 3.3 V supply. |
| 15 | CLKA4 (Note 3) | Buffered clock output, Bank A. |
| 16 | CLKOUT (Note 3) | Buffered output, internal feedback on this pin. |

[^0]Table 3. MAXIMUM RATINGS

| Parameter | Min | Max | Unit |
| :--- | :---: | :---: | :---: |
| Supply Voltage to Ground Potential | -0.5 | +7.0 | V |
| DC Input Voltage (Except REF) | -0.5 | $\mathrm{V}_{\mathrm{DD}}+$ <br> 0.5 | V |
| DC Input Voltage (REF) | -0.5 | 7 | V |
| Storage Temperature | -65 | +150 | ${ }^{\circ} \mathrm{C}$ |
| Maximum Soldering Temperature (10 sec) |  | 260 | ${ }^{\circ} \mathrm{C}$ |
| Junction Temperature |  | 150 | ${ }^{\circ} \mathrm{C}$ |
| Static Discharge Voltage (per MIL-STD-883, Method 3015) |  | $>2000$ | V |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Table 4. RECOMMENDED OPERATING CONDITIONS

| Parameter | Description | Min | Max | Unit |
| :---: | :--- | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{DD}}$ | Supply Voltage | 3.0 | 3.6 | V |
| $\mathrm{~T}_{\mathrm{A}}$ | Operating Temperature (Ambient Temperature) | Industrial <br> Commercial | -40 | 85 |
|  |  | ${ }^{\circ} \mathrm{C}$ |  |  |
| $\mathrm{C}_{\mathrm{L}}$ | Load Capacitance, below 100 MHz |  | 30 | pF |
| $\mathrm{C}_{\mathrm{L}}$ | Load Capacitance, from 100 MHz to 133 MHz |  | 10 | pF |
| $\mathrm{C}_{\mathrm{IN}}$ | Input Capacitance |  | 7 | pF |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

Table 5. ELECTRICAL CHARACTERISTICS $\mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}$ to $3.6 \mathrm{~V}, \mathrm{GND}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$

| Parameter | Description | Test Conditions | Min | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {IL }}$ | Input LOW Voltage (Note 5) |  |  | 0.8 | V |
| $\mathrm{V}_{\mathrm{IH}}$ | Input HIGH Voltage (Note 5) |  | 2.0 |  | V |
| IIL | Input LOW Current | $\mathrm{V}_{\text {IN }}=0 \mathrm{~V}$ |  | 50.0 | $\mu \mathrm{A}$ |
| IIH | Input HIGH Current | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\mathrm{DD}}$ |  | 100.0 | $\mu \mathrm{A}$ |
| VOL | Output LOW Voltage | $\begin{aligned} & \mathrm{I} \mathrm{OL}=8 \mathrm{~mA}(-1) \\ & \mathrm{I}_{\mathrm{OL}}=12 \mathrm{~mA}(-1 \mathrm{H}) \end{aligned}$ |  | 0.4 | V |
| $\mathrm{V}_{\mathrm{OH}}$ | Output HIGH Voltage | $\begin{aligned} & \mathrm{I}_{\mathrm{OH}}=-8 \mathrm{~mA}(-1) \\ & \mathrm{I}_{\mathrm{OH}}=-12 \mathrm{~mA}(-1 \mathrm{H}) \end{aligned}$ | 2.4 |  | V |
| $\mathrm{I}_{\mathrm{DD}}$ | Supply Current (Commercial Temp) | Unloaded outputs at 66.67 MHz , Select inputs at $V_{D D}$ |  | 34 | mA |
| $\mathrm{I}_{\mathrm{DD}}$ | Supply Current (Industrial Temp) |  |  | $\begin{aligned} & 50 \\ & 34 \\ & 19 \end{aligned}$ | mA |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
5. REF input has a threshold voltage of $\mathrm{V}_{\mathrm{DD}} / 2$.

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Table 6. SWITCHING CHARACTERISTICS $\mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}$ to $3.6 \mathrm{~V}, \mathrm{GND}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ (Note 6)

| Parameter | Description | Test Conditions | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $1 / \mathrm{t}_{1}$ | Output Frequency | 30 pF load 10 pF load | $\begin{aligned} & 15 \\ & 15 \end{aligned}$ |  | $\begin{aligned} & 100 \\ & 133 \end{aligned}$ | MHz |
| $1 / \mathrm{t}_{1}$ | $\begin{array}{ll} \hline \text { Duty Cycle }=\left(\mathrm{t}_{2} / \mathrm{t}_{1}\right) * 100 \\ -1 \mathrm{H}) & (-1, \\ & (-1 \mathrm{H}) \end{array}$ | $\begin{aligned} \text { Measured at } 1.4 \mathrm{~V} \text {, FOUT } & =66.67 \\ \mathrm{MHz} & <50 \mathrm{MHz} \end{aligned}$ | $\begin{aligned} & 40 \\ & 45 \end{aligned}$ | $\begin{aligned} & 50 \\ & 50 \end{aligned}$ | $\begin{aligned} & 60 \\ & 55 \end{aligned}$ | \% |
| $\mathrm{t}_{3}$ | $\begin{array}{ll}\text { Output Rise Time } & (-1) \\ & (-1 \mathrm{H})\end{array}$ | Measured between 0.8 V and 2.0 V |  |  | $\begin{aligned} & 2.5 \\ & 1.5 \end{aligned}$ | ns |
| $\mathrm{t}_{4}$ | Output Fall Time | Measured between 2.0 V and 0.8 V |  |  | 1.5 | ns |
| $\mathrm{t}_{5}$ | Output-to-Output Skew | All outputs equally loaded |  |  | 250 | ps |
| $\mathrm{t}_{6}$ | Delay, REF Rising Edge to CLKOUT Rising Edge | Measured at $\mathrm{V}_{\mathrm{DD}} / 2$ |  | 0 | $\pm 350$ | ps |
| $\mathrm{t}_{7}$ | Device-to-Device Skew | Measured at $\mathrm{V}_{\mathrm{DD}} / 2$ on the CLKOUT pins of the device |  | 0 | 700 | ps |
| $\mathrm{t}_{8}$ | Output Slew Rate | Measured between 0.8 V and 2.0 V using Test Circuit \#2 | 1 |  |  | $\mathrm{V} / \mathrm{ns}$ |
| $\mathrm{t}_{\mathrm{J}}$ | Cycle-to-Cycle Jitter | Measured at 66.67 MHz , loaded outputs |  |  | 200 | ps |
| tıock | PLL Lock Time | Stable power supply, valid clock presented on REF pin |  |  | 1.0 | ms |

6. All parameters specified with loaded outputs in PLL-Mode.

## Zero Delay and Skew Control

All outputs should be uniformly loaded to achieve Zero Delay between input and output. Since the CLKOUT pin is the internal feedback to the PLL, its relative loading can adjust the input-output delay.

For applications requiring zero input-output delay, all outputs, including CLKOUT, must be equally loaded. Even if CLKOUT is not used, it must have a capacitive load equal to that on other outputs, for obtaining zero-input-output delay.

## SWITCHING WAVEFORMS



Figure 3. Duty Cycle Timing


Figure 4. All Outputs Rise/Fall Time


Figure 5. Output - Output Skew


Figure 6. Input - Output Propagation Delay


Figure 7. Device - Device Skew

## TEST CIRCUITS



Figure 8. Test Circuit \#1


Figure 9. Test Circuit \#2 For parameter $\mathrm{t}_{\mathbf{8}}$ (output slew rate) on $\mathbf{- 1} \mathrm{H}$ devices

ORDERING INFORMATION

| Device | Marking | Operating Range | Package | Shipping $^{\dagger}$ |
| :---: | :---: | :---: | :---: | :---: |
| NB2309Al1DR2G | 2309 Al1G | Industrial \& Commercial | SOIC-16 <br> (Pb-Free) | 2500 Tape \& Reel |
| NB2309Al1DTR2G | 2309 <br> Al1 | Industrial \& Commercial | TSSOP-16 <br> (Pb-Free) | 2500 Tape \& Reel |
| NB2309Al1HDTR2G | 2309 <br> Al1H | Industrial \& Commercial | TSSOP-16 <br> (Pb-Free) | 2500 Tape \& Reel |

$\dagger$ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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[^0]:    2. Weak pulldown.
    3. Weak pulldown on all outputs.
    4. Weak pullup on these inputs.
